Electronic Patent Application Fee Transmittal								
Application Number:	10801208							
Filing Date:	16-Mar-2004							
Title of Invention:	Methods of manufacturing semiconductor devices having a ruthenium layer via automatic layer deposition							
First Named Inventor/Applicant Name:	Kwang-hee Lee							
Filer:	D. Randal Ayers/Michele McMahan							
Attorney Docket Number:	5649-1277							
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Utility under 35 USC 111(a) Filing Fees								
Description		Fee Code	Quantity	Amount	Sub-Total in USD(\$)			
Basic Filing:								
Pages:								
Claims:								
Miscellaneous-Filing:								
Petition:								
Patent-Appeals-and-Interference:								
Notice of appeal		1401	1	540	540			
Post-Allowance-and-Post-Issuance:								
Extension-of-Time:								

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
	Total in USD (\$)			540